

Ruggedized AI Inference Platform supporting 130W NVIDIA® RTX GPU and Intel® 14th/13th/ 12th-Gen Core™ Processor

FEATURES

- Supports Intel® 14th/13th/12th-Gen Core™ 24C/ 32T 35W/ 65W LGA1700 CPU
- 1x PCIe x16 slot@Gen3, 16-lanes PCIe signals in Cassette for installing an NVIDIA® graphics card up to 130W TDP (Max. graphics card dimension is 188 mm(L) x 131 mm(W), dual slot allocation)
- Support NVIDIA® RTX series GPU card up to 130W TDP
- 5 x 2.5GbE and 1xGbE with on special request PoE+ (ports 3~6)
- 1 x USB 3.2 Gen2x2 (20 Gbps) port in type-C connector with screw-lock
- 4 x USB 3.2 Gen2x1 (10 Gbps) ports in type-A connectors
- 2 x USB 3.2 Gen1x1 (5 Gbps) ports in type-A connectors
- 7 x USB 3.2
- 2 x USB 2.0
- 2 x RS232/422/485 (COM1/2), 2 x RS232 (COM3/4)
- 1 x Mini PCIe, 1 x Full-size mini PCI Express socket
- M.2 2280 M key socket (Gen4x4) supporting NVMe SSD
- Accommodates two 2.5" SATA HDD/ SSD with RAID 0/ 1 support*
- 1 x VGA 1920x 1200, 1 x DVI-D 1920x1200, 1 x Display port 4096x2304
- MezIO™ interface for add-on expansion
- CE/FCC Class A, according to EN 55032 & EN 55035
- 240 mm (W) x 225 mm (D) x 110.5 mm (H)
- 25°C to 60°C wide temperature rugged operation (need to have special RAM and SSD)
- Power supply: DC 8~48V



SPECIFICATIONS

CPU	:	Gen. 14; Gen. 12; Gen. 13
Memory Type	:	DDR5
Max. Memory Capacity	:	64
Chipset	:	Intel Q670E
Power Input	:	DC 8~48V
Operating Temp.	:	-25°C to 60°C
Chok/Vibration	:	Vibration Resistance MIL-STD-810G, Method 514.6 Category 4, with optional damping Shock Resistance MIL-STD-810G, Method 516.6 Procedure I with optional damping
Forsyning	:	8~48Vdc
Grafik	:	Integrated Intel® UHD Graphics 770
Montering	:	Wall-mount
Mål og vægt	:	3.89 kg
PoE	:	yes



SPECIFICATIONS

RAM	:	max. 64
EMC	:	CE, FCC Class A (EN 55032, EN 55035)
Antal Video Udgange	:	3
Antal LAN Porte	:	6
Antal USB	:	9
Antal Serial	:	4

